NSN 5962-01-122-7630

Memory Microcircuit - Page 1 of 1



View Online at https://aerobasegroup.com/nsn/5962-01-122-7630 **Body Length:** 1.230 inches **Body Width:** Between 0.580 inches and 0.600 inches **Body Height:** 0.210 inches **Maximum Power Dissipation Rating:** 1.0 watts **Operating Tempurature Range:** -55.0/+70.0 degrees celsius Storage Tempurature Range: -65.0/+125.0 degrees celsius **End Application:** F-16 81755 **Features Provided:** Burn in and hermetically sealed and programmable **Inclosure Material:** Ceramic **Inclosure Configuration:** Dual-in-line **Output Logic Form:** Metal oxide-semiconductor logic **Input Circuit Pattern:** 10 input **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: 0.5 volts power source **Memory Device Type:** Rom **Test Data Document:** 16340-500709 drawing (this is the basic governing drawing, such as a contractor drawing, original equipment manufacturer drawing, etc.; excludes any specification, standard or other document that may be referenced in a basic governing drawing) **Terminal Type And Quantity:** 24 printed circuit Shelf Life: N/a **Unit Of Measure:**

Demilitarization: Yes - demil/mli

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